

ELCH07-NB5060J6J8283910-F3H

Received
<input checked="" type="checkbox"/> MASS PRODUCTION
<input type="checkbox"/> PRELIMINARY
<input type="checkbox"/> CUSTOMER DESIGN
DEVICE NO. : DHE-0003015
PAGE : 13

Revised record		
REV.	DESCRIPTION	RELEASE DATE
1	New spec	Feb.05.2016
2	For ECR*55269 add Page.13 DISCLAIMER	Nov.23.2016

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Features

- Feature of the device : small package with high efficiency
- Typical luminous flux@ 1A : 260 lm
- Optical efficiency@1A : 76.4 lm/W
- ESD protection (according to JEDEC 3b) (HBM air or contact discharge) up to 8KV
- Binning Parameters : Brightness, Forward Voltage and Chromaticity
- Grouping parameter: total luminous flux, color coordinates.
- RoHS compliant & Pb free
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Applications

- Mobile Phone Camera Flash(Camera flash light /strobe light for mobile devices)
- Torch light for DV(Digital Video) application
- Indoor lighting applications
- Signal and symbol luminaries for orientation marker lights (e.g. steps, exit ways, etc.)
- TFT backlighting
- Exterior and interior illumination applications
- Decorative and Entertainment Lighting
- Exterior and interior automotive illumination

Device Selection Guide

Chip Materials	Emitted Color
InGaN	White

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
DC Forward Current (Torch Mode)	I _F	350	mA
Peak Pulse Current	I _{Pulse}	1200	mA
ESD Resistance (JEDEC 3b)	V _B	8000	V
Reverse Voltage	V _R	Note 1	V
Junction Temperature	T _j	125	°C
Operating Temperature	T _{Opr}	-40 ~ +85	°C
Storage Temperature	T _{Stg}	-40 ~ +100	°C
Soldering Temperature	T _{Sol}	260	°C
Allowable Reflow Cycles	n/a	2	Cycles
Substrate Temperature	T _s	70(IF=1000mA)	°C
Viewing Angle ₍₂₎	2θ _{1/2}	120	Deg
Power Dissipation (Pulse Mode)	P _d	4.74	W

Notes:

- 1. The Chin series LEDs are not designed for reverse bias used.
- 2. View angle measurement tolerance±5°
- 3. Avoid operating Chin series LEDs at maximum operating temperature exceed 1 hour.
- 4. All specification are assured by reliability test for 1000hr, IV degradation less than 30%.
- 5. All reliability item are tested under good thermal management with 1.0 x 1.0 cm² MCPCB
- 6. Peak pulse current shall be applied under conditions as max duration time 400 ms and max duty cycle 10%
- 7. Operate LED component at maximum rating conditions continuously will cause possible permanent damage and de-rating parameters. Exercise multiple maximum rating parameters simultaneously should not be allowed. When maximum rating parameters are applied over a long period will result potential reliability issue.

JEDEC Moisture Sensitivity

Level	Floor Life		Soak Requirements Standard	
	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≤ 30°C / 85% RH	168 (+5/-0)	85°C / 85% RH

Electro-Optical Characteristics (Ts=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Flux ₍₁₎	Iv	220	260	----	lm	I _F =1000mA
Forward Voltage ₍₂₎₍₃₎	V _F	2.85	----	3.95	V	
Color Temperature	CCT	5000	----	6000	K	

Forward Voltage Binning

Bin	Symbol	Min.	Typ.	Max.	Unit	Condition
2832	V _F	2.85	----	3.25	V	I _F =1000mA
3235	V _F	3.25	----	3.55		
3539	V _F	3.55	----	3.95		

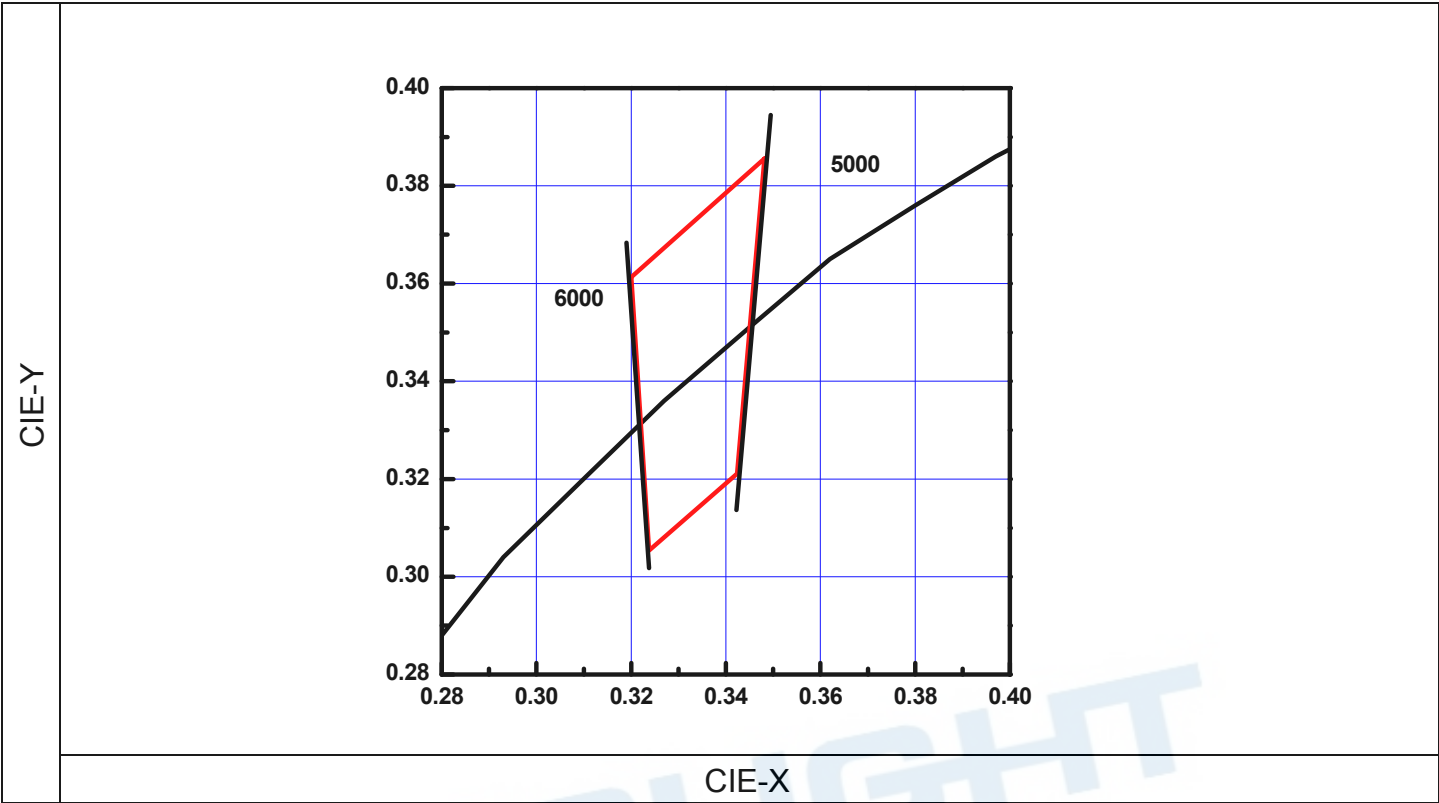
Luminous Flux Binning

Bin	Symbol	Min.	Typ.	Max.	Unit	Condition
J6	Iv	220	----	250	Iv	I _F =1000mA
J7	Iv	250	----	300		
J8	Iv	300	----	330		

Notes:

- 1. Luminous Flux, illuminance measurement tolerance : ±10%
- 2. Forward voltage measurement tolerance : ±0.1V
- 3. Electric and optical data is tested at 50 ms pulse condition.
- 4. Temperature of solder pad : 25°C

White Bin Structure

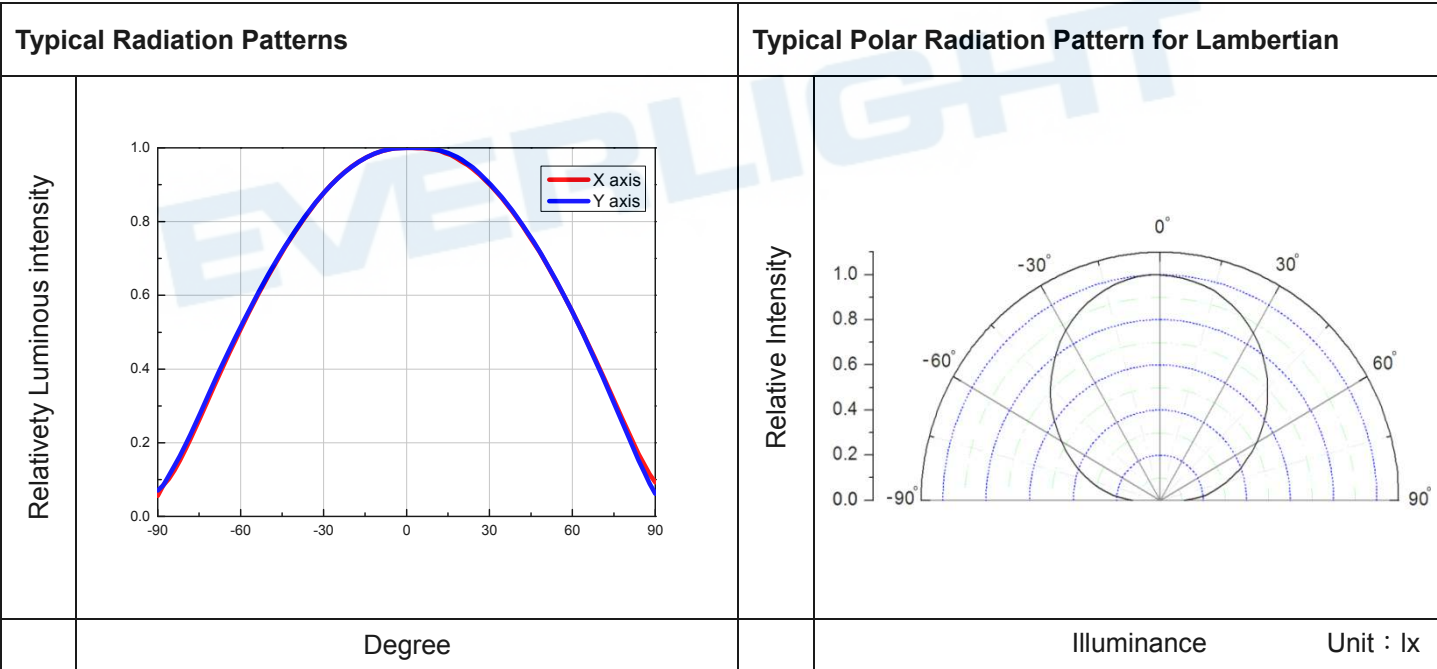
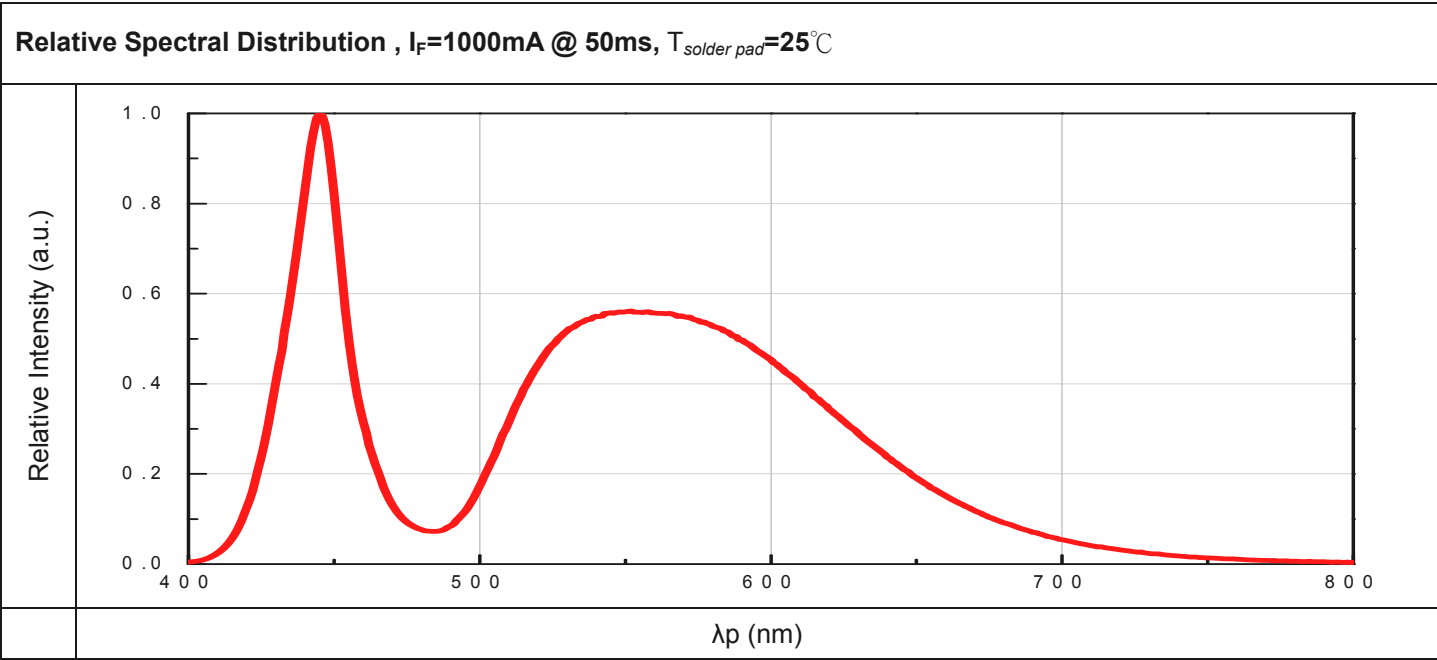


Bin	CIE-X	CIE-Y	Reference Range
5060	0.3482	0.3856	5000 ~ 6000K
	0.3200	0.3613	
	0.3238	0.3054	
	0.3424	0.3211	

Notes:

- 1. Color coordinates measurement allowance : ± 0.01
- 2. Color bins are defined at $I_F=1000\text{mA}$ operation.

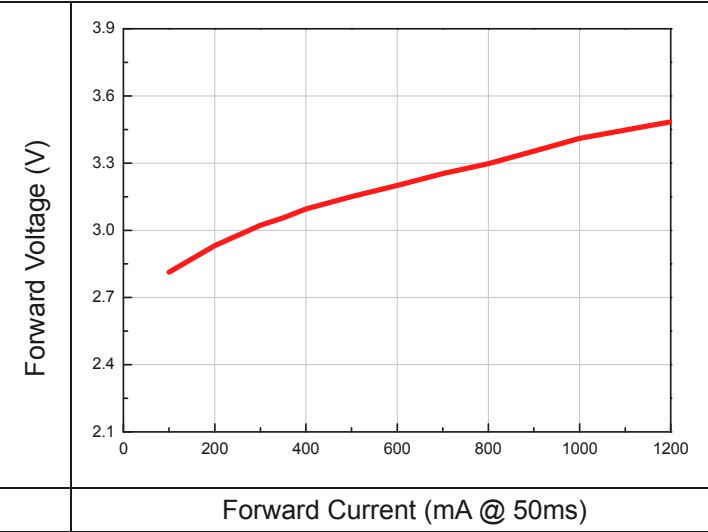
Typical Electro-Optical Characteristics Curves



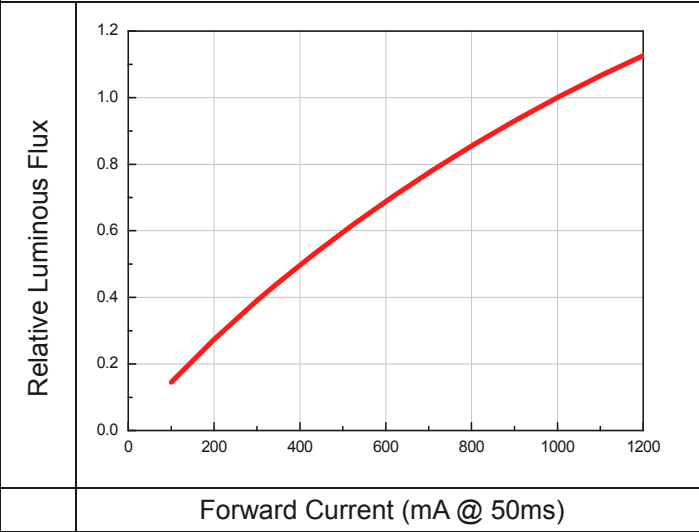
Notes:

- 1. $2\theta_{1/2}$ is the off axis from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is $\pm 5^\circ$

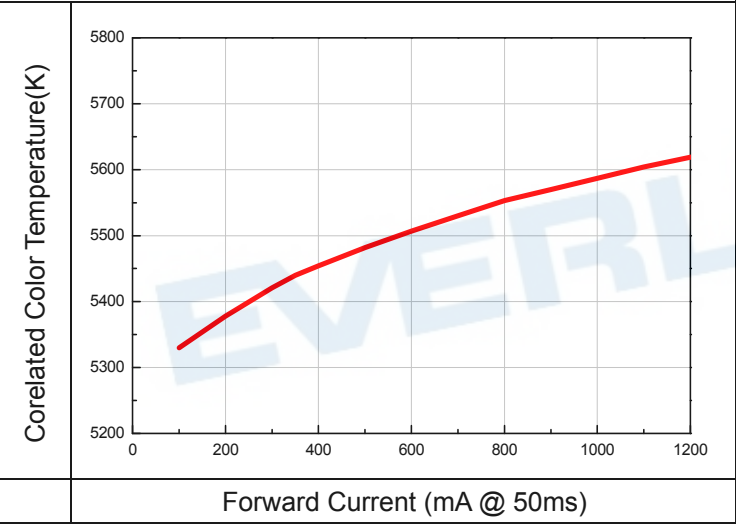
Forward Voltage vs. Forward Current (T_{solder pad}=25°C)



Relative Luminous Flux vs. Forward Current (T_{solder pad}=25°C)



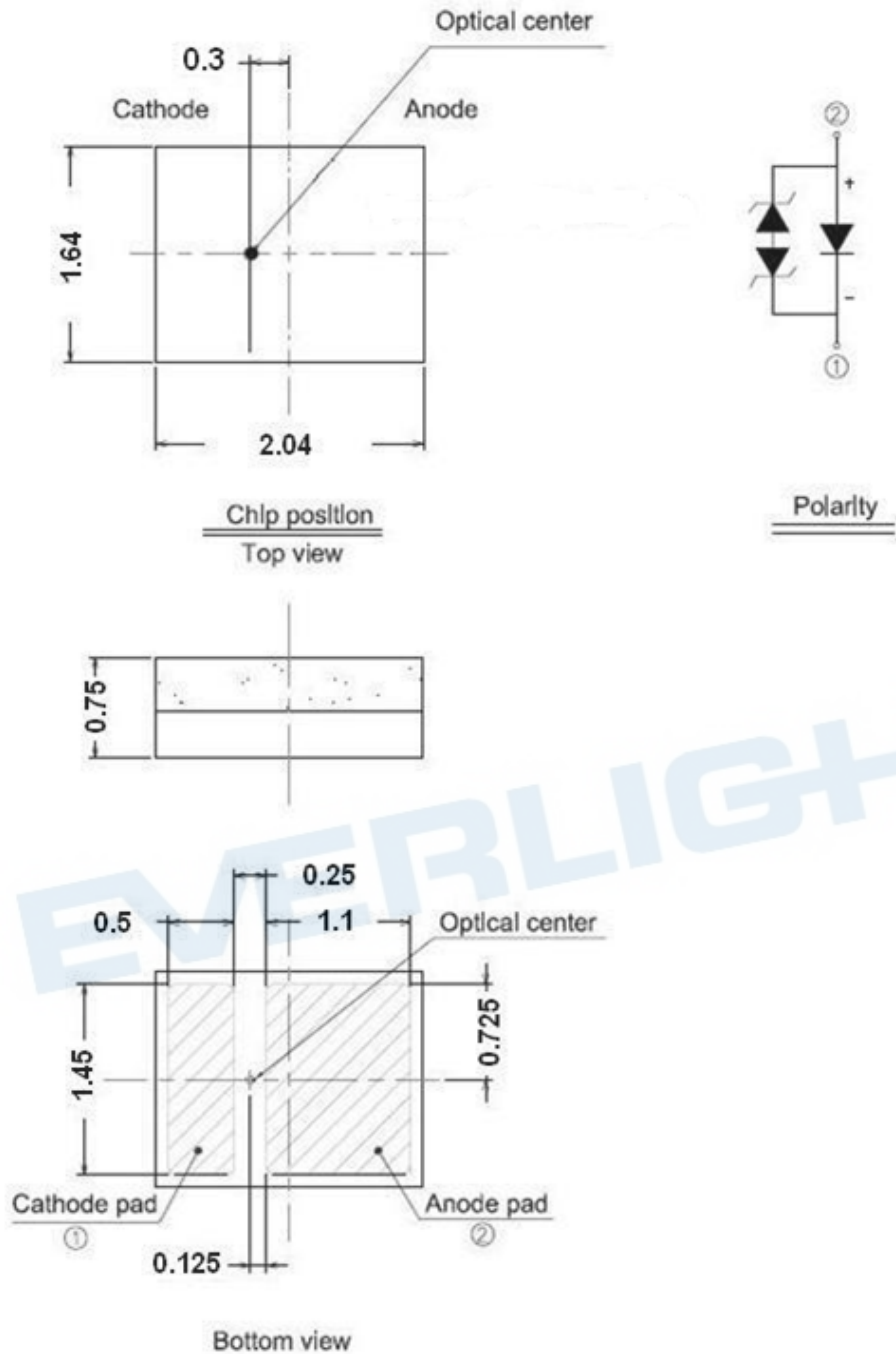
CCT vs. Forward Current (T_{soldering pad}=25°C)



Notes:

- 1. All correlation data is tested under superior thermal management with 1 x 1 cm² MCPCB.

Package Dimension



Notes:

1. Dimensions are in millimeters.
2. Tolerances unless mentioned are $\pm 0.1\text{mm}$.

Moisture Resistant Packing Materials

Product Labeling

RoHS

Pb

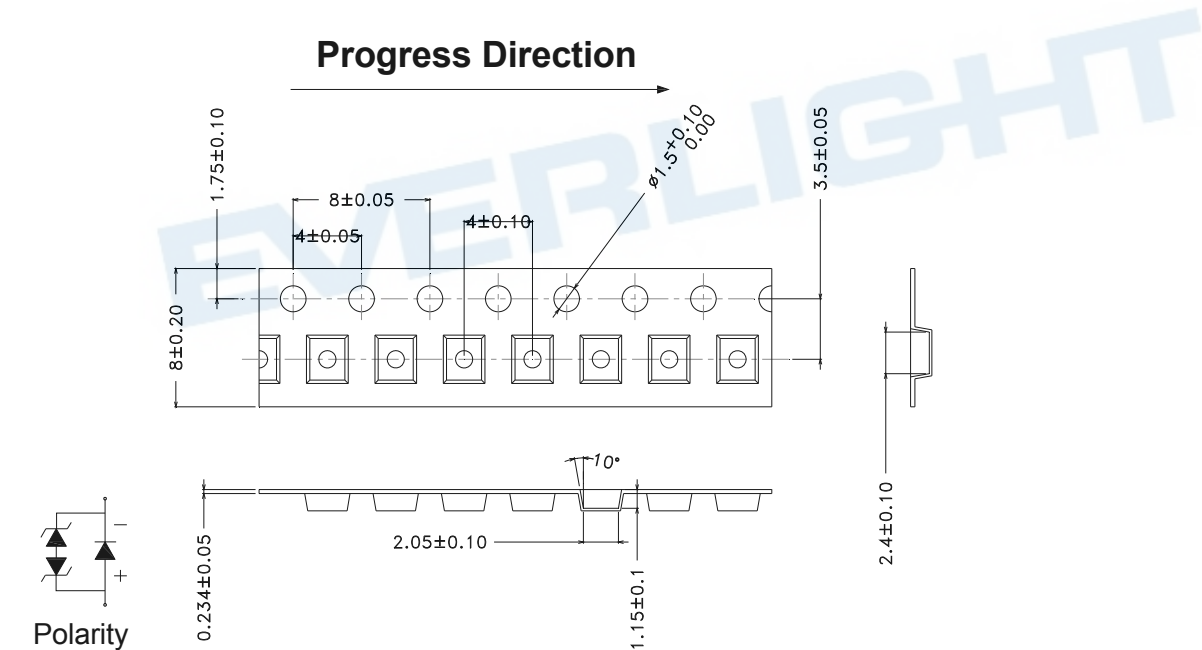
EVERLIGHT

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CPN: XXXXXXXXXXXXXXXXXXXX
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX
P/N: XXXXXXXXXXXX
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX
LOT NO: Y150716XXX-XXXXXXXXXX-XXXXXXXXXX
QTY: 0123456789 HUE: XXXXXXXXXXXX
CAT: XXXXXXXXXXXX REF: XXXXXXXXXXXX
REFERENCE: BTPYMMDDXXXXX
MSL-X MADE IN XXXXXX

- CPN:Customer’s Product Number
- P/N:Everlight Product Number
- LOT NO:Lot Number
- QTY:Packing Quantity
- CAT:Luminous Flux (Brightness) Bin
- HUE:Color Bin
- REF:Forward Voltage Bin
- REFERENCE:Reference
- MSL-X:MSL Level

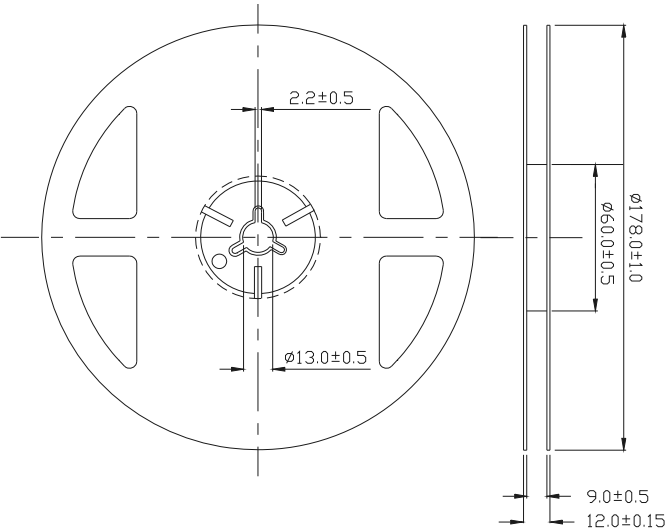
Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel (Minimum Package Quantity :1000 PCS)



Notes:

1. Dimensions are in millimeters.

Emitter Reel Dimensions



Notes:

- 1. Dimensions are in millimeters.

Moisture Resistant Packing Process



Reflow Soldering Characteristics

Soldering and Handling

1. Over-current-proof

Though CHIN series has conducted ESD protection mechanism, customers must not use the device in reverse and should apply resistors for extra protection. Otherwise, slight voltage shift may cause enormous current shift and burn out failure would happen.

2. Storage

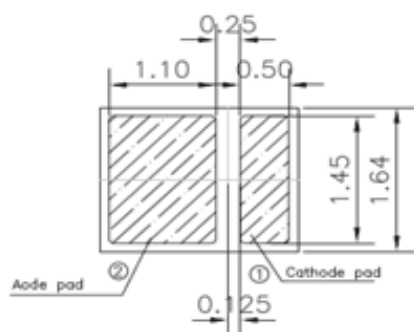
- 2.1 Do not open the moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be stored at temperature less than 30°C and relative humidity less than 90%.
- 2.3 After opening the package, the LEDs should be stored at temperature less than 30°C and relative humidity less than 85%.
- 2.4 If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be implemented based on the following conditions: Pre-curing at 60±5°C for 24 hours.

3. Thermal Management

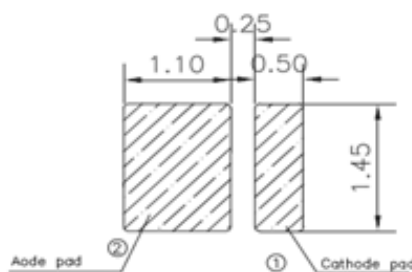
- 3.1 For maintaining the high flux output and achieving reliability, Chin series LEDs should be mounted on a metal core printed circuit board (MCPCB), with proper thermal connection to dissipate approximately 1W to 5W of thermal energy under normal operation.
- 3.2 Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LEDs lifetime will decrease critically.
- 3.3 When operating, the solder pad temperature (or the board temperature nearby the LED) must be controlled under 70°C.

4. Soldering Condition

4.1 Soldering Pad



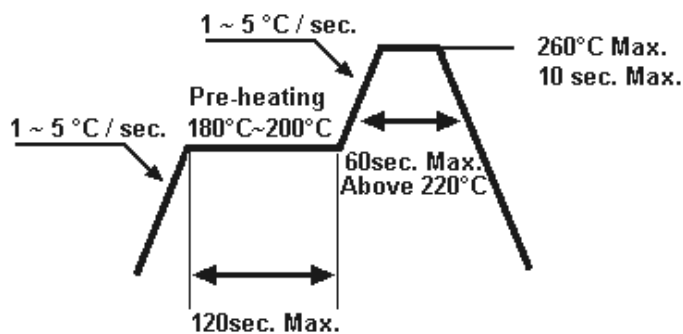
Component bottom view



Recommended soldering pattern layout

4.2 For Reflow Process

4.2.1 Lead reflow soldering temperature profile



4.2.2 Reflow soldering should not be done more than two times.

4.2.3 While soldering, do not put stress on the LEDs during heating.

4.2.4 After soldering, do not warp the circuit board.

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1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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